

83A, 600V SUPER JUNCTION MOS POWER TRANSISTOR

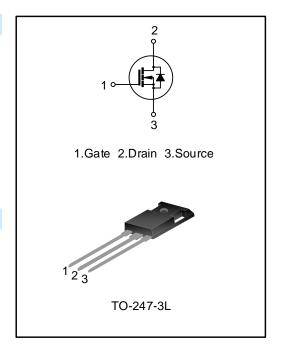
DESCRIPTION

SVSP60R033P7HD4 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior.

Furthermore, it's universal applicable, i.e., suitable for hard and soft switching topologies.

FEATURES

- $\bullet \quad 83A,\,600V,\,R_{DS(on)(typ.)}\!\!=\!\!28.5m\Omega@V_{GS}\!\!=\!\!10V$
- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- High peak current capability
- 100% avalanche tested
- Pb-free lead plating
- · RoHS compliant



KEY PERFORMANCE PARAMETERS

| Characteristics | Ratings | Unit |
|--------------------------|---------|------|
| V _{DS} | 600 | V |
| V _{GS(th)} | 3.0~5.0 | V |
| R _{DS(on),max.} | 33 | mΩ |
| I _{D.pulse} | 249 | A |
| Q _{g.typ.} | 170 | nC |

ORDERING INFORMATION

| Part No. | Package | Marking | Hazardous Substance Control | Packing Type |
|-----------------|-----------|-----------|-----------------------------|--------------|
| SVSP60R033P7HD4 | TO-247-3L | P60R033P7 | Halogen free | Tube |

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ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

| Obamaskaniskiaa | Course al | Test conditions | Ratings | | | Unit |
|--------------------------------------|-----------------------------------|--|---------|------|------|------|
| Characteristics | Symbol | Test conditions | Min. | Тур. | Max. | Onit |
| Drain-source Voltage | V _{DS} | | | | 600 | V |
| Gate-source Voltage (Static) | V_{GS} | | -20 | | 20 | V |
| Gate-source Voltage (Dynamic) | V_{GS} | AC(f>1 Hz) | -30 | | 30 | V |
| Drain Current | I _D | T _C =25°C | | | 83 | Α |
| Diam Current | ID | T _C =100°C | | | 52 | Α |
| Drain Current Pulsed (Note 1) | I _{DM} | T _C =25°C | | | 249 | Α |
| Power Dissipation (Note 2) | P_D | T _C =25°C | | | 544 | W |
| Single Pulsed Avalanche Energy | E _{AS} | L=79mH, V_{DD} =100V, R_{G} =25 Ω , starting temperature T_{J} =25 $^{\circ}$ C | | | 3228 | mJ |
| Single Pulsed Current | I _{AS} | | | | 8.4 | Α |
| Reverse Diode dv/dt | dv/dt | V _{DS} =0~400V, I _{SD} <= I _S , T _J =25°C | | | 50 | V/ns |
| MOSFET dv/dt Ruggedness | dv/dt | V _{DS} =0~400V | | | 50 | V/ns |
| Operation Junction Temperature Range | TJ | | -55 | | 150 | °C |
| Storage Temperature Range | T _{stg} | | -55 | | 150 | °C |
| Continuous Diode Forward Current | Is | T _C =25°C, integral reverse P-N junction diode in the MOSFET | - | | 83 | А |
| Diode Pulse Current | I _S , _{pulse} | Junionori diode in the MOSFET | | | 249 | Α |
| Maximum Diode Commutation Speed | di/dt | V _{DS} =0~400V, I _{SD} <= I _S , T _J =25°C | | | 900 | A/µs |

THERMAL CHARACTERISTICS

| Characteristics | Sumbol | Test conditions | Ratings | | | Unit | |
|--------------------|-----------------|------------------|---|--|--|------|------|
| Character | ristics | Symbol | Min. Typ. Max. | | | | |
| Thermal | Resistance, | D | | | | 0.23 | °C/W |
| Junction-case, Bot | tom | R _{eJC} | | | | | |
| Thermal | Resistance, | R _{eJA} | | | | 50 | 0000 |
| Junction-ambient | | Көја | | | | 50 | °C/W |
| Soldering Tempera | ature (in line) | Tsold | 15 ⁺² ₋₀ sec, 1time | | | 260 | °C |

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ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED,TJ=25°C)

Static characteristics

| Characteristics | Symbol | Symbol Test conditions - | Ratings | | | Unit |
|------------------------------|---------------------|---|---------|------|------|-------|
| Characteristics | Syllibol | rest conditions | Min. | Тур. | Max. | Offic |
| Drain-source Breakdown | BV _{DSS} | V _{GS} =0V, I _D =250µA | 600 | | | V |
| Voltage | D V DSS | V _{GS} =0V, I _D =230μA | 000 | | | V |
| Drain aguros Logkago Current | I _{DSS} | V _{DS} =600V, V _{GS} =0V, T _J =25°C | | | 1.0 | |
| Drain-source Leakage Current | | V _{DS} =600V, V _{GS} =0V, T _J =125°C | | 23 | | μΑ |
| Gate-source Leakage Current | I _{GSS} | V _{GS} =±20V, V _{DS} =0V | | | ±100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{GS}=V_{DS}$, $I_{D}=250\mu A$ | 3.0 | | 5.0 | V |
| Static Drain-source | В | V _{GS} =10V, I _D =42A, T _J =25°C | | 28.5 | 33 | C |
| On State Resistance | R _{DS(on)} | V _{GS} =10V, I _D =42A, T _J =150°C | | 66 | | mΩ |
| Gate Resistance | R _G | f=1MHz | | 2.0 | | Ω |

Dynamic characteristics

| Characteristics | Cumbal | Symbol Test conditions | Ratings | | | Lleit |
|------------------------------|--------------------------|--|---------|------|------|-------|
| Gnaracteristics | Symbol Test conditions — | Min. | Тур. | Max. | Unit | |
| Input Capacitance | C _{iss} | 6 4 M I = \/ O\/ | | 7700 | | |
| Output Capacitance | Coss | f=1MHz, V _{GS} =0V, | | 227 | | pF |
| Reverse Transfer Capacitance | C _{rss} | V _{DS} =200V | | 10 | | |
| Turn-on Delay Time | t _{d(on)} | \\ 400\\\\ 10\\\ D 470 | | 60 | | |
| Turn-on Rise Time | t _r | V_{DD} =400V, V_{GS} =10V, R_{G} =4.7 Ω , | | 74 | | |
| Turn-off Delay Time | t _{d(off)} | I _D =42A (Notes 2, 4) | | 134 | | ns |
| Turn-off Fall Time | t _f | (Notes 3, 4) | | 43 | | |
| Total Gate Charge | Q_g | V 400V V 40V | | 169 | | |
| Gate-source Charge | Q_{gs} | V _{DD} =480V, V _{GS} =10V, | | 61 | | nC |
| Gate-drain Charge | Q_{gd} | I _D =42A (Notes 3, 4) | | 71 | | |
| Gate-plateau Voltage | V _{plateau} | (Notes 3, 4) | | 7.5 | | V |

Reverse diode characteristics

| Characteristics | Sumbol Test conditions | Test conditions | Ratings | | | - Unit |
|-------------------------------|------------------------|--|---------|------|------|--------|
| Characteristics | Symbol | rest conditions | Min. | Тур. | Max. | Onit |
| Diode Forward Voltage | V _{SD} | I _S =42A, V _{GS} =0V | | | 1.4 | V |
| Reverse Recovery Time | T _{rr} | I _S =42A, V _{GS} =0V, VR=400V, | | 173 | | ns |
| Reverse Recovery Charge | Qrr | dI _F /dt=100A/μs | | 1.23 | | μC |
| Reverse Recovery Peak Current | I _{rrm} | (Note 3) | | 14 | | Α |

Notes:

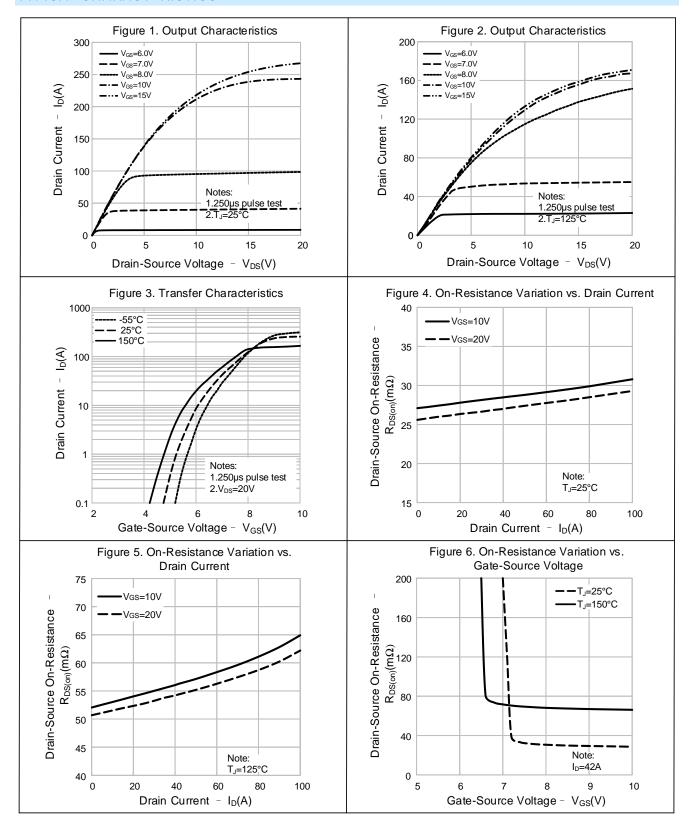
- Pulse time 5µs;
- 2. The dissipation power will change with temperature, derating above 25°C: 4.35W/°C;
- 3. Pulse Test: Pulse width ≤300µs, Duty cycle≤2%;
- 4. Essentially independent of operating temperature.

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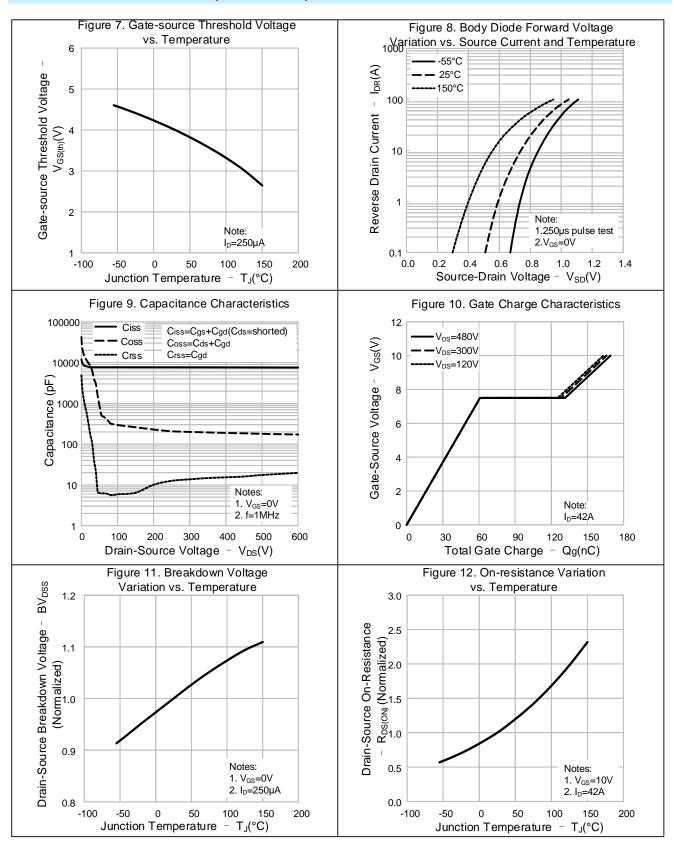
TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS (CONTINUED)

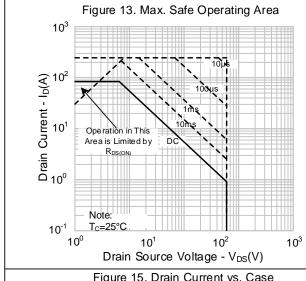


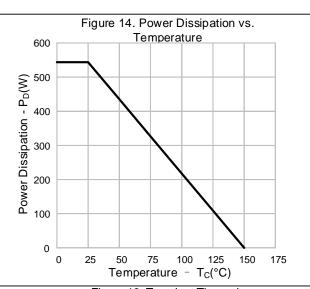
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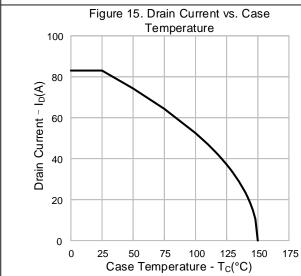


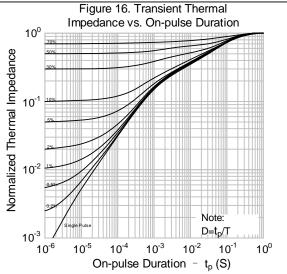


TYPICAL CHARACTERISTICS (CONTINUED)







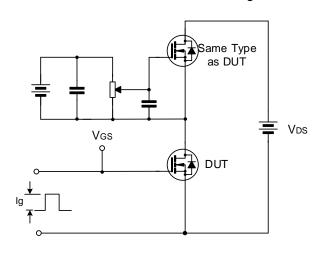


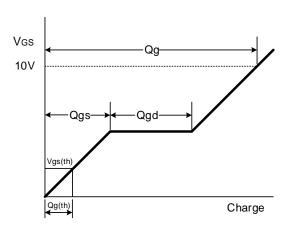
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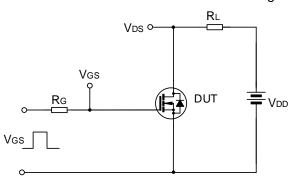
TYPICAL TEST CIRCUIT

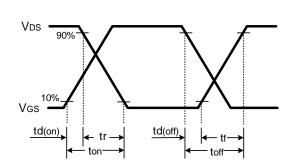
Gate Charge Test Circuit & Waveform



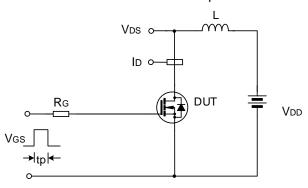


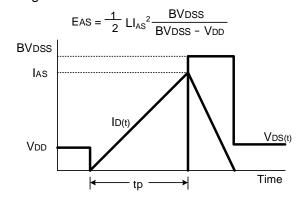
Resistive Switching Test Circuit & Waveform





Unclamped Inductive Switching Test Circuit & Waveform

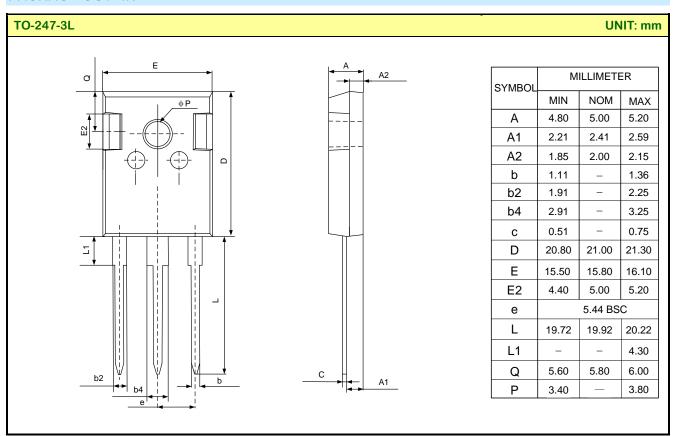




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PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
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First release

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